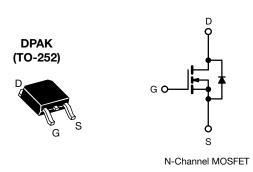
**Vishay Siliconix** 

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# **E Series Power MOSFET**



PRODUCT SUMMARY					
$V_{DS}$ (V) at $T_J$ max.	650				
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.320			
Q <sub>g</sub> max. (nC)	52				
Q <sub>gs</sub> (nC)	6				
Q <sub>gd</sub> (nC)	13				
Configuration	Single				

### FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (C<sub>iss</sub>)
- Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
- Welding
- Induction heating
- Motor drives
- Battery chargers
- Renewable energy
- Solar (PV inverters)

ORDERING INFORMATION				
Package	DPAK (TO-252)			
Lead (Pb)-free and halogen-free	SiHD9N60E-GE3			

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub>	= 25 °C, unle	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V <sub>DS</sub>	600	v
Gate-source voltage			V <sub>GS</sub>	± 30	v
Continuous drain current (T <sub>J</sub> = 150 °C)	V at 10 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	- I <sub>D</sub> -	9	
	V <sub>GS</sub> at 10 V	$T_C = 100 \ ^\circ C$		6	А
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	22	
Linear derating factor				0.63	W/°C
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	111	mJ
Maximum power dissipation			P <sub>D</sub>	78	W
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Drain-source voltage slope	T <sub>J</sub> = 125 °C		-1) / / -1+	70	
Reverse diode dV/dt <sup>d</sup>			dV/dt	40	V/ns
Soldering recommendations (peak temperature) <sup>c</sup> For 10 s			300	°C	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b.  $V_{DD}$  = 140 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 2.8 A.

c. 1.6 mm from case.

d.  $I_{SD} \leq I_D, \, dI/dt$  = 100 A/µs, starting  $T_J$  = 25 °C.

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COMPLIANT

HALOGEN

FREE

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THERMAL RESISTANCE RATINGS								
PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	- 62		°C/W				
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	- 1.6				0/10		
SPECIFICATIONS (T <sub>J</sub> = 25 $^{\circ}$ C, u	<b>SPECIFICATIONS</b> ( $T_J = 25 \text{ °C}$ , unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static								
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> =	250 µA	600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	$I_D = 1 \text{ mA}$	-	0.71	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{GS}, I_D =$	250 µA	2.5	-	4.5	V
		,	$V_{GS} = \pm 20$	V	-	-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>		$V_{GS} = \pm 30$	V	-	-	± 1	μA
Zere gete veltage drein overent		V <sub>DS</sub> =	= 600 V, V <sub>G</sub>	<sub>iS</sub> = 0 V	-	-	1	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 V	′, V <sub>GS</sub> = 0 V	/, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I	<sub>D</sub> = 4.5 A	-	0.320	0.368	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> :	= 30 V, I <sub>D</sub> =	= 4.5 A	-	2.4	-	S
Dynamic								
Input capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V	<u>,</u>	-	778	-	
Output capacitance	C <sub>oss</sub>	-	$V_{\rm DS} = 100  \rm V,$		-	48	-	
Reverse transfer capacitance	C <sub>rss</sub>	f = 1 MHz		-	4	-		
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	$V_{DS} = 0 V$ to 480 V, $V_{GS} = 0 V$		-	29	-	pF	
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	138	-		
Total gate charge	Qg				-	26	52	
Gate-source charge	Q <sub>gs</sub>	$V_{GS} = 10 \text{ V}$ $I_D = 4.5 \text{ A}, V_{DS} = 480 \text{ V}$		-	6	-	nC	
Gate-drain charge	Q <sub>gd</sub>	-			-	13	-	
Turn-on delay time	t <sub>d(on)</sub>				-	14	28	
Rise time	t <sub>r</sub>	V <sub>DD</sub> =	480 V, I <sub>D</sub>	= 4.5 A,	-	13	26	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GS}$ = 10 V, $R_g$ = 9.1 $\Omega$		-	31	62	ns	
Fall time	t <sub>f</sub>			-	12	24		
Gate input resistance	R <sub>g</sub>	f = 1	MHz, ope	n drain	0.4	1.2	2.4	Ω
Drain-Source Body Diode Characteristic	cs							
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	9		
Pulsed diode forward current	I <sub>SM</sub>			-	-	22	A	
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 4.5 A, V <sub>GS</sub> = 0 V		-	-	1.2	V	
Reverse recovery time	t <sub>rr</sub>				-	207	414	ns
Reverse recovery charge	Q <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = I_S = 4.5 \text{ A},$ dl/dt = 100 A/µs, V <sub>R</sub> = 25 V		-	2.2	4.4	μC	
Reverse recovery current	I <sub>RRM</sub>				20	-	A	

### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDSS.

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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

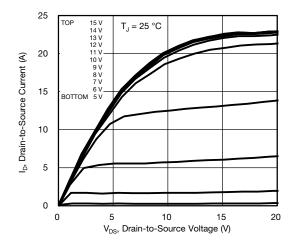
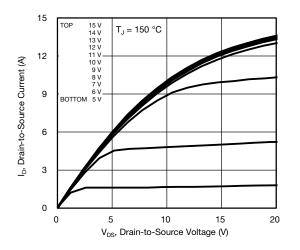
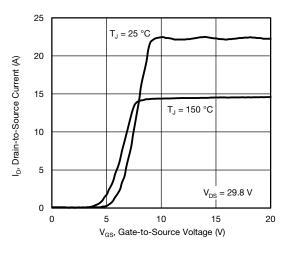


Fig. 1 - Typical Output Characteristics









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3.0 = 4.5 A R<sub>DS(on)</sub>, Drain-to-Source On-Resistance 2.5 2.0 (Normalized) 1.0 = 10 V V<sub>GS</sub> 0.5 0 -60 -40 -20 0 20 40 60 80 100 120 140 160 T<sub>J</sub>, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

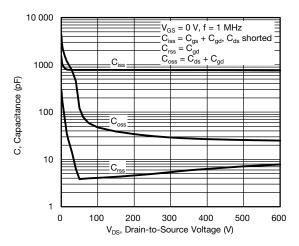


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

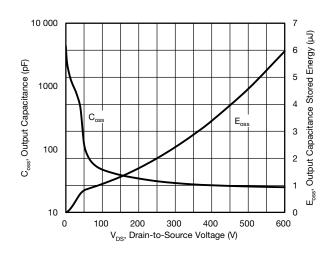


Fig. 6 -  $C_{\rm oss}$  and  $E_{\rm oss}$  vs.  $V_{\rm DS}$ 

3 For technical questions, contact: <u>hvm@vishay.com</u>

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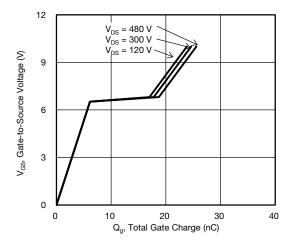


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

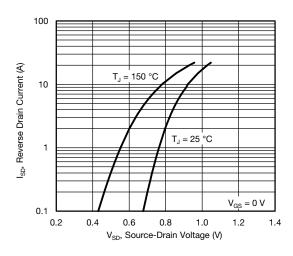


Fig. 8 - Typical Source-Drain Diode Forward Voltage

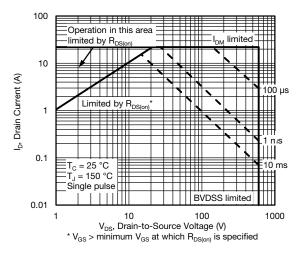


Fig. 9 - Maximum Safe Operating Area

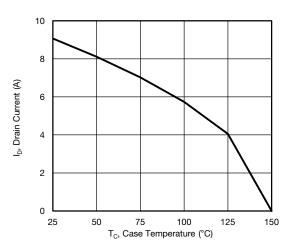


Fig. 10 - Maximum Drain Current vs. Case Temperature

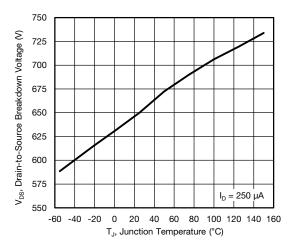


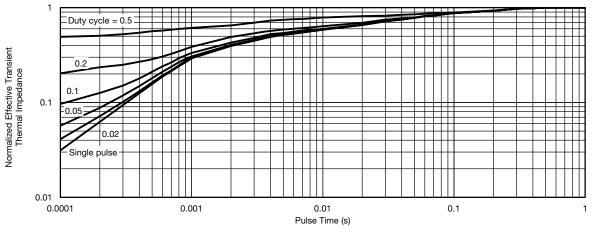
Fig. 11 - Temperature vs. Drain-to-Source Voltage

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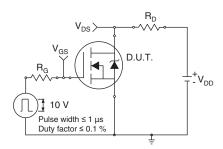


Fig. 13 - Switching Time Test Circuit

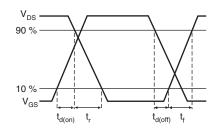


Fig. 14 - Switching Time Waveforms

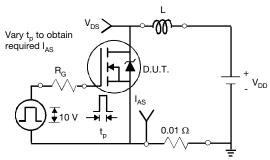


Fig. 15 - Unclamped Inductive Test Circuit

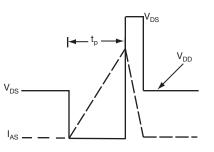


Fig. 16 - Unclamped Inductive Waveforms

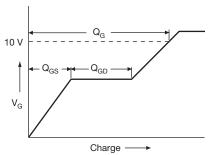


Fig. 17 - Basic Gate Charge Waveform

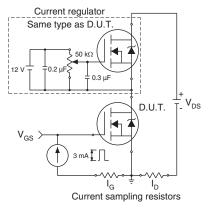


Fig. 18 - Gate Charge Test Circuit

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### Peak Diode Recovery dV/dt Test Circuit

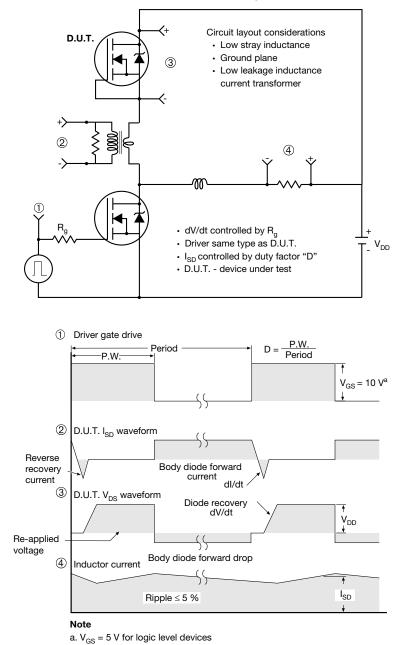


Fig. 19 - For N-Channel

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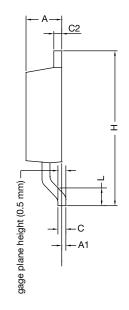


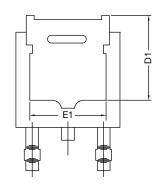


**TO-252AA Case Outline** 

## VERSION 1: FACILITY CODE = Y







	MILLIMETERS			
DIM.	MIN.	MAX.		
А	2.18	2.38		
A1	-	0.127		
b	0.64	0.88		
b2	0.76	1.14		
b3	4.95	5.46		
С	0.46	0.61		
C2	0.46	0.89		
D	5.97	6.22		
D1	4.10	-		
E	6.35	6.73		
E1	4.32	-		
Н	9.40	10.41		
е	2.28	2.28 BSC		
e1	4.56	4.56 BSC		
L	1.40	1.78		
L3	0.89	1.27		
L4	-	1.02		
L5	1.01	1.52		

### Note

• Dimension L3 is for reference only



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## VERSION 2: FACILITY CODE = N



	MILLIMETERS		
DIM.	MIN.	MAX.	
А	2.18	2.39	
A1	-	0.13	
b	0.65	0.89	
b1	0.64	0.79	
b2	0.76	1.13	
b3	4.95	5.46	
С	0.46	0.61	
c1	0.41	0.56	
c2	0.46	0.60	
D	5.97	6.22	
D1	5.21	-	
E	6.35	6.73	
E1	4.32 -		
е	2.29 BSC		
Н	9.94 10.34		

	MILLIMETERS			
DIM.	MIN.	MAX.		
L	1.50	1.78		
L1	2.74	2.74 ref.		
L2	0.51 BSC			
L3	0.89	1.27		
L4	-	1.02		
L5	1.14	1.49		
L6	0.65	0.85		
θ	0°	10°		
θ1	0°	15°		
θ2	25°	35°		

### Notes

• Dimensioning and tolerance confirm to ASME Y14.5M-1994

• All dimensions are in millimeters. Angles are in degrees

• Heat sink side flash is max. 0.8 mm

Radius on terminal is optional

ECN: E22-0399-Rev. R, 03-Oct-2022 DWG: 5347

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## **RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads Dimensions in Inches/(mm)

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